Specifications

Drawing No.	USY1M-H1-15382-00	1/8
Issued Date.	Jul,28,2015	

Messrs: Digi-key

Note: Part Number will be revised in case of specification change.

Product Type	Quartz Crystal	
Series	CX2016DB	
Frequency	16000kHz	
Customer Part Number	-	
Customer Specification Number	-	
KYOCERA Part Number	CX2016DB16000D0WZRC1	
Remarks Pb-Free, RoHS Compliant, MSL 1		

Customer Approval

Approval Signature	Approved Date	
	Department	
	Person in charge	

Seller

KYOCERA Crystal Device Corporation (Sales Division) 6 Takeda Tobadono-cho, Fushimi-ku, Kyoto 612-8501 Japan TEL. No. 075-604-3500 FAX. No. 075-604-3501

Manufacturer

KYOCERA Crystal Device Corporation Crystal Units Division 5850, Higashine-Koh, Higashine-Shi, Yamagata 999-3701 Japan TEL. No. 0237-43-5611 FAX. No. 0237-43-5615

Design Department	Quality Assurance	Approved by	Checked by	Issued by
KYOCERA Crystal Device Corporation Crystal Unit Application Engineering Section Crystal Units Division	S.Itoh	T.Soda	A.Muraoka	Y.Nozaki

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Revision History

Rev.No.	Description of revise	Date	Approved by	Checked by	Issued by
00	First Edition	Jul,28,2015	T.Soda	A.Muraoka	Y.Nozaki

1. APPLICATION

The purpose of this document is applied to CX2016DB quartz crystal.

2. KYOCERA PART NUMBER

CX2016DB16000D0WZRC1

3. RATINGS

Items	SYMB.	Rating	Unit	Remarks
Operating Temperature range	Topr	-25~+75	deg. C	
Storage Temperature range	Tstg	-40~+85	deg. C	

4. CHARACTERISTICS 4-1 ELECTRICAL CHARACTERISTICS

Items	Electrical Specification			Test Condition	Remarks		
	SYMB.	Min	Тур.	Max	Unit		
Mode of Vibration		F	undamenta	ł			
Nominal Frequency	F0		16		MHz		
Nominal Temperature	T _{NOM}		25		deg. C		
Load Capacitance	CL		8.0		pF		
Frequency tolerance	df/F					25deg.C	
Frequency Temperature Characteristics	df/t	-40.0		+40.0	PPM	-25~+75deg.C	
Frequency Aging Rate						25deg.C	1 st year
Equivalent Series Resistance	ESR			130	Ohms	CL=SERIES	
Shunt Capacitance	C0			3.0	pF		
Drive Level	Pd	0.01		100	μW		
Insulation Resistance	IR	500			M ohms	100V(DC)	

Measurement Condition

Frequency measurement

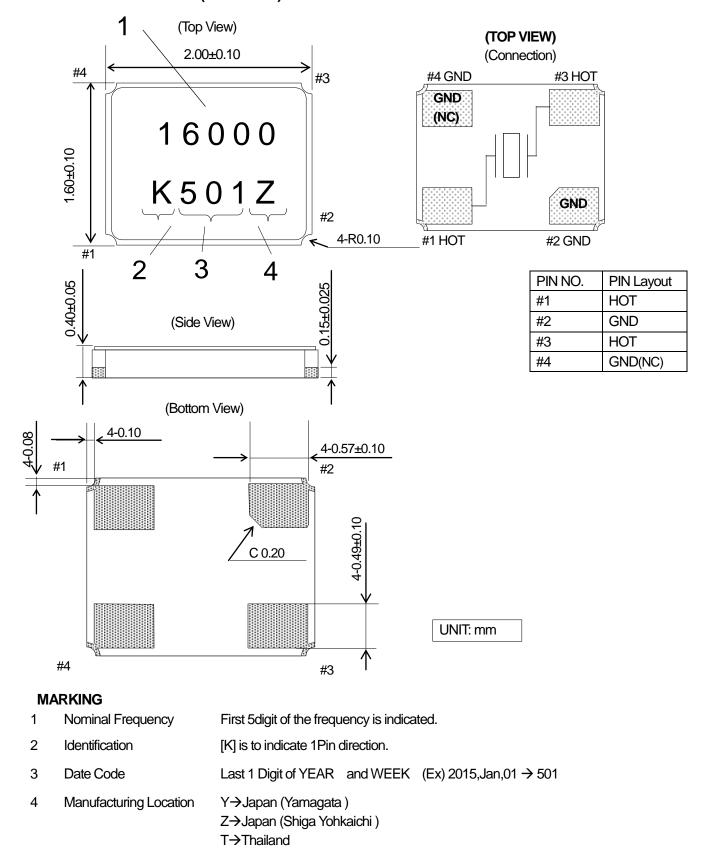
Measuring instrument

: IEC PI-Network Test Fixture

Equivalent series resistance (ESR) measurement

Measuring instrument: IEC PI-Network Test FixtureLoad Capacitance: Series

KYOCERA Crystal Device Corporation



5. APPEARANCES, PHYSICAL DIMENSION OUTLINE DIMENSION (not to scale)

*The font of marking is for reference only.

$\begin{array}{c|c} 0.9 \\ \hline 0.5 \\ \hline 0.9 \\ \hline 0.5 \\ \hline 0.9 \\ \hline 0.9 \\ \hline 0.5 \\ \hline 0.9 \\$

6. RECOMMENDED LAND PATTERN (not to scale)

UNIT : mm

7. Enviromental requirements

After conducting the following tests, component needs to meet below conditions. Frequency: Fluctuation within +/-10 x 10^{-6} CI: Fluctuation within +/-20% or 5 Ω whichever is larger

7.1	Resistance to Shock	Test condition 3 times natural drop from 100cm onto hard wooden board.		
7.2	Resistance to Vibration	Test condition frequency Amplitude Cycle time Direction	: 10 - 55 - 10 Hz : 1.5mm : 15 minutes : X,Y,Z (3direction),2h each.	
7.3	Resistance to Heat	temperature o	/stal unit shall be stored at a of +85±2°C for 500h and subjected to ature for 1h before measurement.	
7.4	Resistance to Cold	temperature o	/stal unit shall be stored at a f -40±2°C for 500h and subjected to ature for 1h before measurement.	
7.5	Thermal Shock	cycles showr to room temp Cycle	ystal unit shall be subjected to 500 temperature in in table below, Then it shall be subjected berature for 1h before mesurement. :-40 \pm 2°C (30min.) \rightarrow +25 \pm 2°C(5min.) +85 \pm 2°C(30min.) \rightarrow +25 \pm 2°C(5min.)	

7.6	Resistance to Moisture	Test condition
		The quartz crystal unit shall be stored at a
		temperature of +60±2°C with relative humidity of
		90% to 95% for 240 h. Then it shall be subjected
		to room temperature for 1h before measurement.

7.7 Soldering condition 1.) Type of solder

Material \rightarrow lead free solder paste Melting point \rightarrow +220±5°C 2.) Reflow temp.profile

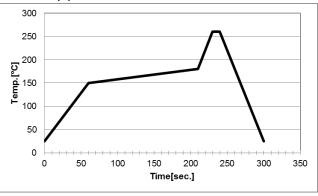
	Temp [°C]	Time[sec]			
Preheating	+150 to +180	150 (typ.)			
Peak	+260±5	10 (max.)			
Total	-	300 (max.)			

Frequency shift : ±2ppm

3.) Hand Soldering +350°C 3 sec max

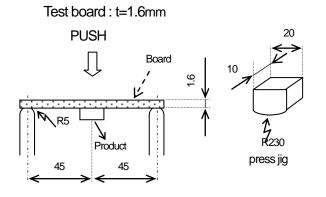
4.) Reflow Times 2 times in below Reflow temp. profile

Reflow temp.profile



7.8 Bending Strength

Solder this product in center of the circuit board (40mm X 100mm), and add deflection of 3mm.



UNIT : mm

8. Cautions for use

(1) Soldering upon mounting

There is a possibility to influence product characteristics when Solder paste or conductive glue comes in contact with product lid or surface.

(2) When using mounting machine

Please minimize the shock when using mounting machine to avoid any excess stress to the product.

(3) Conformity of a circuit

We strongly recommend to make sure that Negative resistance (Gain) of IC is designed to be 3 times the ESR (Equivalent Series Resistance) of crystal unit.

9. Storage conditions

Please store product in below conditions, and use within 6 months. Temperature +18 to +30°C, and Humidity of 20 to 70 % in the packaging condition.

10. Manufacturing location

Kyocera Crystal Device Corporation Yamagata Plant Kyocera Crystal Device Corporation Shiga Yohkaichi Plant Kyocera Crystal Device (Thailand) Co., Ltd

11. Quality Assurance

To be guaranteed by Kyocera Crystal Device Quality Assurance Division

12. Quality guarantee

In case when Kyocera Crystal Device Corporation rooted failure occurred within 1year after its delivery, substitute product will be arranged based on discussion. Quality guarantee of product after 1year of its delivery is waivered.

13. Others

In case of any questions or opinions regarding the Specification, please have it in written manner within 45 days after issued date.